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- **Controlled Baseline**
 - One Assembly/Test Site, One Fabrication
- **Extended Temperature Performance of** -40°C to 125°C
- **Enhanced Diminishing Manufacturing** Sources (DMS) Support
- **Enhanced Product-Change Notification**
- Qualification Pedigree†
- **Supports Mixed-Mode Signal Operation** (5-V Input and Output Voltages With 3.3-V V_{CC})
- **Typical V_{OLP} (Output Ground Bounce)** <0.8 V at $V_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$
- **Supports Unregulated Battery Operation** Down to 2.7 V
- Ioff and Power-Up 3-State Support Hot
- † Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- **ESD Protection Exceeds JESD 22**
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)

(TOP VIEW)

DB OR PW PACKAGE

10E	1	\cup	20] v _{cc}
1A1	2		19	20E
2Y4			18] 1Y1
1A2			17	2A4
2Y3			16] 1Y2
1A3	6		15	2A3
2Y2			14] 1Y3
1A4			13	2A2
2Y1			12] 1Y4
GND	10		11	2A1
				,

description/ordering information

This octal buffer and line driver is designed specifically for low-voltage (3.3-V) V_{CC} operation, but with the capability to provide a TTL interface to a 5-V system environment.

The SN74LVTH244A is organized as two 4-bit line drivers with separate output-enable $(\overline{\sf OE})$ inputs. When $\overline{\sf OE}$ is low, the device passes data from the A inputs to the Y outputs. When \overline{OE} is high, the outputs are in the high-impedance state.

To ensure the high-impedance state during power up or power down, OE should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

ORDERING INFORMATION

TA	PACKAGE [‡]		ORDERABLE PART NUMBER	TOP-SIDE MARKING	
-40°C to 125°C	SSOP – DB	Tape and reel	SN74LVTH244AQDBREP	LH244AEP	
-40 C to 125 C	TSSOP - PW	Tape and reel	SN74LVTH244AQPWREP	LH244AEP	

Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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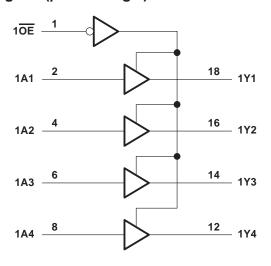
description/ordering information (continued)

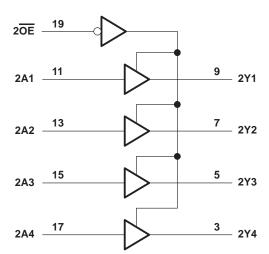
This device is fully specified for hot-insertion applications using I_{off} and power-up 3-state. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

FUNCTION TABLE (each buffer)

INP	JTS	OUTPUT		
OE	Α	Y		
L	Н	Н		
L	L	L		
Н	Χ	Z		

logic diagram (positive logic)







SN74LVTH244A-EP 3.3-V ABT OCTAL BUFFER/DRIVER WITH 3-STATE OUTPUTS

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V _{CC}	
Voltage range applied to any output in the high-impedance	
or power-off state, V _O (see Note 1)	
Voltage range applied to any output in the high state, V _O (see Note 1)	\dots -0.5 V to V _{CC} + 0.5 V
Current into any output in the low state, IO	96 mA
Current into any output in the high state, IO (see Note 2)	48 mA
Input clamp current, $I_{ K }(V_{ I } < 0)$	–50 mA
Output clamp current, I _{OK} (V _O < 0)	–50 mA
Package thermal impedance, θ _{JA} (see Note 3): DB package	70°C/W
PW package	83°C/W
Storage temperature range, T _{stg} (see Note 4)	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 - 2. This current flows only when the output is in the high state and $V_O > V_{CC}$.
 - 3. The package thermal impedance is calculated in accordance with JESD 51-7.
 - 4. Long term high-temperature storage and/or extended use at maximum recommended operating conditions may result in a reduction of overall device life. See www.ti.com/ep_quality for additional information on enhanced plastic packaging.

recommended operating conditions (see Note 5)

			MIN	MAX	UNIT
Vcc	Supply voltage			3.6	V
VIH	High-level input voltage		2		V
V _{IL}	Low-level input voltage			8.0	V
VI	Input voltage			5.5	V
loh	High-level output current			-24	mA
loL	Low-level output current			32	mA
Δt/Δν	Input transition rise or fall rate	Outputs enabled		10	ns/V
Δt/ΔV _{CC}	Power-up ramp rate		200		μs/V
TA	Operating free-air temperature		-40	125	°C

NOTE 5: All unused control inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



SN74LVTH244A-EP 3.3-V ABT OCTAL BUFFER/DRIVER WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT	
٧ıK		V _{CC} = 2.7 V,	I _I = -18 mA			-1.2	V	
		V _{CC} = 2.7 V to 3.6 V,	I _{OH} = -100 μA	V _{CC} -0.	2		V	
Vон		V _{CC} = 2.7 V,	I _{OH} = -8 mA	2.4				
		V _{CC} = 3 V	I _{OH} = -24 mA	2				
		V 07V	I _{OL} = 100 μA			0.2		
\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \		V _{CC} = 2.7 V	$I_{OL} = 24 \text{ mA}$			0.5	V	
VOL		V 2V	$I_{OL} = 16 \text{ mA}$			0.4	V	
		VCC = 3 V	$I_{OL} = 32 \text{ mA}$			0.5		
	On attack in most a	$V_{CC} = 0 \text{ or } 3.6 \text{ V},$	V _I = 5.5 V			50		
	Control inputs	V _{CC} = 3.6 V,	$V_I = V_{CC}$ or GND			±1		
11	Data tanada	V _{CC} = 3.6 V	VI = VCC			1	μΑ	
	Data inputs		V _I = 0			-5		
	Data tamata	V _{CC} = 3 V	V _I = 0.8 V	75			•	
^I I(hold)	Data inputs		V _I = 2 V	-75			μΑ	
lozh		V _{CC} = 3.6 V,	VO = 3 V			5	μА	
lozL		V _{CC} = 3.6 V,	V _O = 0.5 V			-5	μΑ	
lozpu		$V_{CC} = 0 \text{ to } 1.5 \text{ V}, V_{O} = 0.5 \text{ V to } 3 \text{ V}, \overline{OE} = \text{do}$	on't care			±100	μА	
lozpd		$V_{CC} = 1.5 \text{ V to } 0, V_{O} = 0.5 \text{ V to } 3 \text{ V}, \overline{OE} = dc$	on't care			±100	μΑ	
ICC	$V_{CC} = 3.6 \text{ V, } I_{O} = 0, V_{I} = V_{CC} \text{ or GND}$	Outputs high			0.39			
		Outputs low			14	mA		
		Outputs disabled			0.39			
Δl _{CC} ‡	ΔI_{CC}^{\ddagger} $V_{CC} = 3 \text{ V to } 3.6 \text{ V}, \text{ One input at } V_{CC} - 0.6 \text{ V}, \text{ Other inputs at } V_{CC} \text{ or GND}$				0.2	mA		
C _i	$V_1 = 3 \text{ V or } 0$			3		pF		
Со		V _O = 3 V or 0			7		pF	

switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 1)

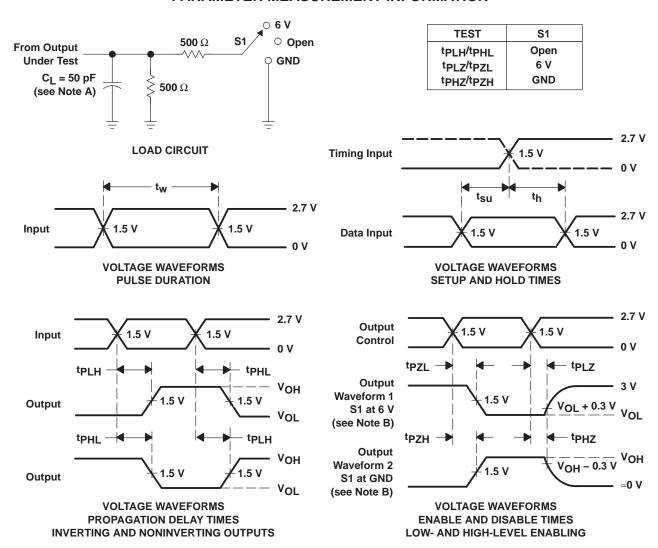
PARAMETER	FROM	TO (OUTPUT)	V _{CC} = 3.3 V ± 0.3 V		V _{CC} = 2.7 V		UNIT
	(INPUT)		MIN	MAX	MIN	MAX	
^t PLH	А	Y	0.5	3.8		4.1	ns
^t PHL			0.5	3.8		3.9	
^t PZH	ŌĒ	V	0.8	5		6	
t _{PZL}		Y	0.8	5		5.4	ns
^t PHZ	ŌĒ	V	1.3	5.5		5.8	
t _{PLZ}	OE	Y	1.2	4.7		4.8	ns



[†] All typical values are at V_{CC} = 3.3 V, T_A = 25°C. ‡ This is the increase in supply current for each input that is at the specified TTL voltage level, rather than V_{CC} or GND.

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PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_I includes probe and jig capacitance.

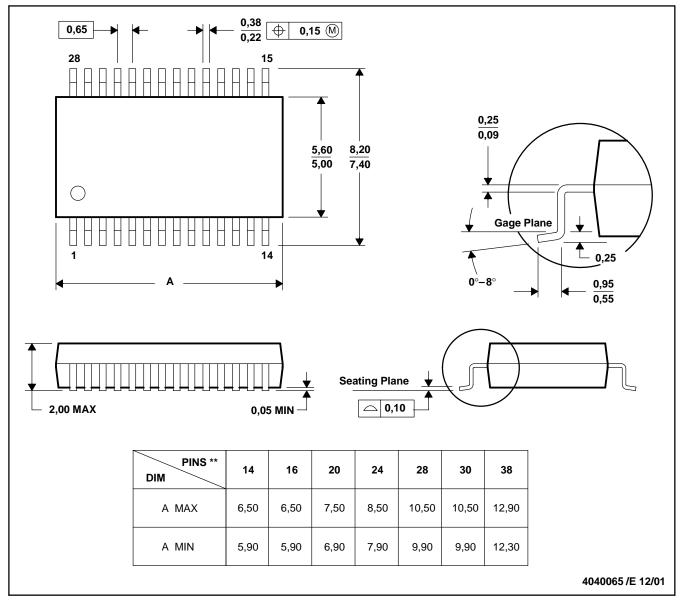
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_Q = 50 \ \Omega$, $t_f \leq 2.5 \ ns$.
- D. The outputs are measured one at a time with one transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.

D. Falls within JEDEC MO-150

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